Frequency Mixer

HJK-251H+

Level 17 (LO Power +17 dBm) 40 to 250 MHz

The Big Deal

- Low conversion loss, 7.0 dB typ.
- High IP3, 32 dBm typ.
- Excellent L-R isolation, 50 dB typ.



CASE STYLE: TTT881

Product Overview

Mini-Circuits' HJK-251H+ is a surface mount, level 17 FET-based frequency mixer with an RF frequency range from 40 to 250 MHz, LO frequency range from 10 to 220 MHz, and IF frequency range from 10 to 90 MHz. Its double-balanced FET configuration achieves an outstanding combination of low conversion loss, low noise figure and high IP3 performance without the need for a DC bias current, ideal for sensitive receiver applications including base stations, mobile radio, radar, and more. The mixer comes housed in a miniature, shielded 6-lead package (0.38 x 0.5 x 0.23"), saving space in tight PCB layouts.

Key Features

Feature	Advantages
High IP3, +32 dBm	Minimizes third order intermodulation products and improves dynamic range in demanding environments where multiple carriers may be present.
Excellent P1dB compression, +20 dBm typ.	Whereas the 1-dB compression point of a diode-based mixer is typically 4 to 6 dB lower than the LO power level, the 1-dB compression point of HJK-251H+ FET-based mixer is +20 dBm higher than the LO signal power. This results in excellent linearity and high dynamic range.
High isolation: • L-R isolation, 50 dB • L-I isolation, 45 dB	Preserves signal integrity from input to output by reducing undesirable signal responses that can degrade system performance.
Low conversion loss, 7 dB	Low conversion loss results in higher output IP3 and better overall system dynamic range.
Small size (0.38 x 0.5 x 0.23")	Saves PCB real estate and accommodates crowded layouts.

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C. The parts covered by this specification document are subject to Mini-Circuit standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits website at www.minicircuits.com/MCLStore/terms.jsp

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Maximum Ratings

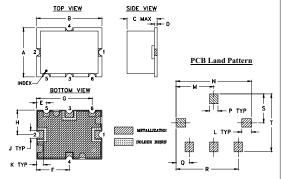
Operating Temperature	-40°C to 85°C			
Storage Temperature	-55°C to 100°C			
LO Power*	+19 dBm			
RF Power	+20 dBm			

Permanent damage may occur if any of these limits are exceeded * Over temperature

Pad Connections

LO	2
RF	1
IF	3
GROUND	4,5,6

Outline Drawing

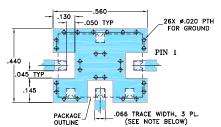


Suggested Layout,

Outline Dimensions (inch)

Α	В	С	D	Е	F	G	Н	J	K
.38	.50	.23	.020	.075	.250	.425	.187	.050	.050
9.65	12.70	5.84	0.51	1.91	6.35	10.80	4.75	1.27	1.27
L	M	N	Р	Q	R	S	Т		wt.
_		N .540				_		ç	wt. grams

Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



- OTE:

 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC
 1. THICKNESS 030" ± .002". COPPER: 1/2 0Z. EACH SIDE.
 FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE
 UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING.
 IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT
 GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED
 A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO
 ENSURE FILLET AND CONNECTION AT GROUND PADS.
 3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DEDOTES PCB COPPER LAVOUT WITH SMOBC (SOLDER
 MASK OVER BARE COPPER), SEE NOTE 2.
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Features

- high IP3, 32 dBm typ.
- excellent L-R isolation, 50 dB typ.; L-I isolation, 45 dB typ.

Applications

- base stations
- · amateur radio
- aeronautical
- · mobile radio radar
- emergency

HJK-251H+



Generic photo used for illustration purposes only

CASE STYLE: TTT881

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost						
Reel Size	Devices/Reel					
7"	10, 20, 50, 100, 200					
13"	500					

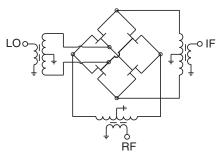
Electrical Specifications at 25°C

Parameter	Min.	Тур.	Max.	Unit			
Frequency Range, RF	40	_	250	MHz			
Frequency Range, LO	10	_	220	MHz			
Frequency Range, IF	10	_	90	MHz			
Conversion Loss	_	7.0	8.5	dB			
LO to RF Isolation	36	50	_	dB			
LO to IF Isolation	32	45	_	dB			
IP3	_	32	_	dBm			
RF Input Power at 1 dB Compression	_	+20	_	dBm			
LO Power	_	+17	+20	dBm			

Typical Performance Data

Frequ	ency	Conversion Loss (dB)	Isolation L-R	Isolation L-I	VSWR RF Port	VSWR LO Port	IP3 (dBm)
RF	LO	LO	LO	LO	LO	LO	LO
MHz	MHz	+17dBm	+17dBm	+17dBm	+17dBm	+17dBm	+17dBm
40.10 52.10 64.10 79.10 91.10 106.10 118.10 130.10 145.10 172.10 184.10 196.10 211.10	10.10 22.10 34.10 49.10 61.10 76.10 88.10 100.10 115.10 127.10 142.10 154.10 181.10	6.52 6.66 6.81 7.02 7.05 6.93 6.82 6.78 6.77 6.86 7.00 7.05 7.04 6.99	65.14 65.97 63.22 60.32 57.80 56.82 56.82 56.80 55.93 54.76 52.76 52.05 52.05 52.45	64.99 59.83 56.26 52.67 50.17 48.33 47.71 47.18 46.40 45.29 44.04 43.57 43.50 43.72	2.40 2.36 2.30 2.30 2.27 2.24 2.20 2.18 2.13 2.08 2.05 2.03	2.19 2.23 2.27 2.33 2.39 2.50 2.59 2.70 2.82 2.93 3.04 3.12 3.18 3.25	36.56 33.25 34.75 34.43 39.59 35.00 33.89 33.58 32.73 32.58 33.52 33.10 30.97 30.11
223.10	193.10	6.95	52.57	43.65	1.95	3.28	29.58
238.10	208.10	6.90	52.53	43.42	2.01	3.31	30.89
250.10	220.10	6.92	52.06	42.97	1.95	3.31	32.31

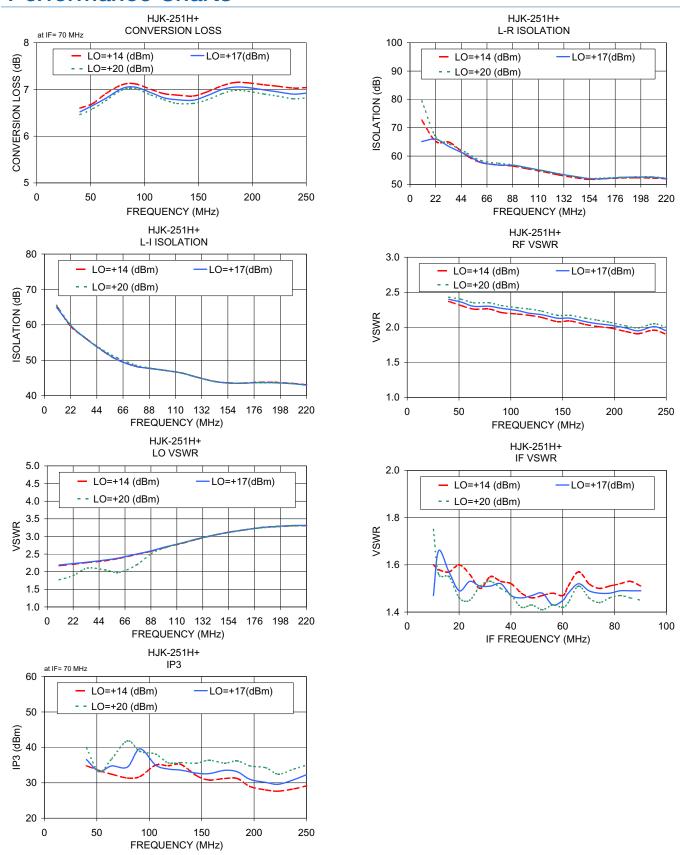
Electrical Schematic



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